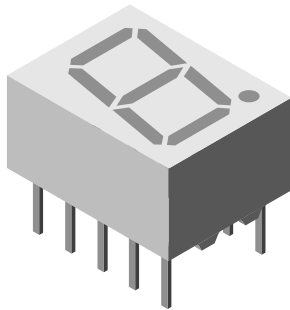




Low Current 10 mm 7-Segment Display



19236

DESCRIPTION

The TDSL31.0 series are 10 mm character seven segment low current LED displays in a very compact package.

The displays are designed for a viewing distance up to 6 m and available in high efficiency red. The grey package surface and the evenly lighted segments provide an optimum on-off contrast.

All displays are categorized in luminous intensity groups. That allows users to assemble displays with uniform appearance.

Typical applications include instruments, panel meters, point-of-sale terminals and household equipment.

FEATURES

- Low power consumption
- Suitable for DC and multiplex operation
- Evenly lighted segments
- Grey package surface
- Untinted segments
- Luminous intensity categorized
- Wide viewing angle
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT

APPLICATIONS

- Panel meters
- Test- and measure-equipment
- Point-of-sale terminals

PRODUCT GROUP AND PACKAGE DATA

- Product group: Display
- Package: 10 mm
- Product series: Low current
- Angle of half intensity: ± 50°

PARTS TABLE														
PART	COLOR	LUMINOUS INTENSITY (µcd)			at I _F (mA)	WAVELENGTH (nm)			at I _F (mA)	FORWARD VOLTAGE (V)			at I _F (mA)	CIRCUITRY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
TDSL3150	Red	180	260	-	2	612	-	625	2	-	1.8	2.4	2	Common anode
TDSL3150-G	Red	450	-	900	2	612	-	625	2	-	1.8	2.4	2	Common anode
TDSL3160	Red	180	260	-	2	612	-	625	2	-	1.8	2.4	2	Common cathode

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
TDSL3150, TDSL3160				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage per segment		V _R	6	V
DC forward current per segment		I _F	15	mA
Peak forward current per segment		I _{FM}	45	mA
Surge forward current per segment	t _p ≤ 10 µs (non repetitive)	I _{FSM}	100	mA
Power dissipation	T _{amb} ≤ 45 °C	P _V	320	mW
Junction temperature		T _j	100	°C
Operating temperature range		T _{amb}	- 40 to + 85	°C
Storage temperature range		T _{stg}	- 40 to + 85	°C
Soldering temperature	t ≤ 3 s, 2 mm below seating plane	T _{sd}	260	°C
Thermal resistance LED junction/ambient		R _{thJA}	180	K/W

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
TDSL3150, TDSL3160, RED							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity per segment ⁽¹⁾ (digit average)	$I_F = 2\text{ mA}$	TDSL3150	I_V	180	260	-	μcd
		TDSL3150-G		450	-	900	
		TDSL3160		180	260	-	
Dominant wavelength	$I_F = 2\text{ mA}$	TDSL3150, TDSL3150-G, TDSL3160	λ_d	612	-	625	nm
Peak wavelength	$I_F = 2\text{ mA}$		λ_p	-	635	-	nm
Angle of half intensity	$I_F = 2\text{ mA}$		ϕ	-	± 50	-	deg
Forward voltage per segment	$I_F = 2\text{ mA}$		V_F	-	1.8	2.4	V
	$I_F = 20\text{ mA}$		V_F	-	2.7	3	V
Reverse voltage per segment	$I_F = 10\text{ }\mu\text{A}$		V_R	6	20	-	V
Junction capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$		C_j	-	30	-	pF

Note

⁽¹⁾ $I_{Vmin.}$ and I_V groups are mean values of all segments (a to g, D1 to D4), matching factor within segments is ≥ 0.5 , excluding decimal points and colon.

LUMINOUS INTENSITY CLASSIFICATION			
GROUP	LIGHT INTENSITY (μcd)		
STANDARD	MIN.		MAX.
E	180		360
F	280		560
G	450		900
H	700		1400
I	1100		2200
K	1800		3600

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

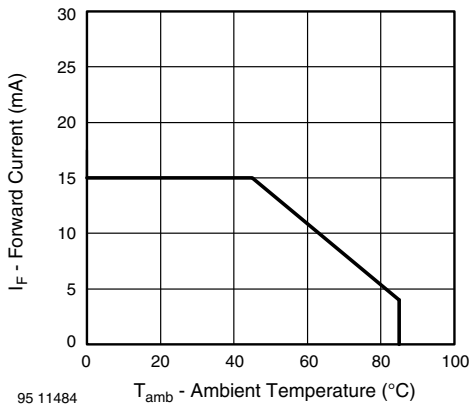


Fig. 1 - Forward Current vs. Ambient Temperature

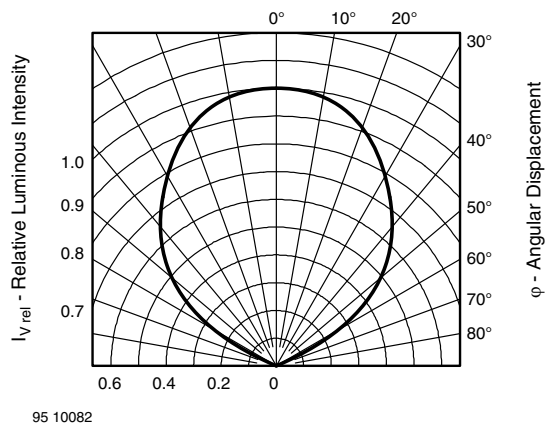


Fig. 2 - Relative Luminous Intensity vs. Angular Displacement

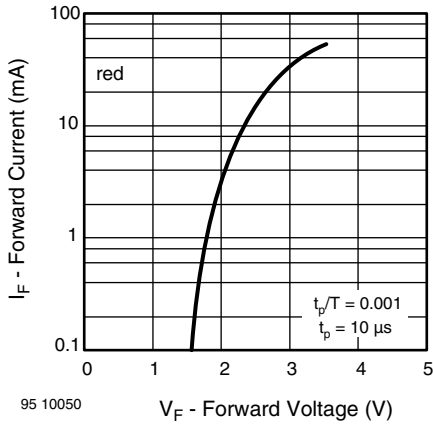


Fig. 3 - Forward Current vs. Forward Voltage

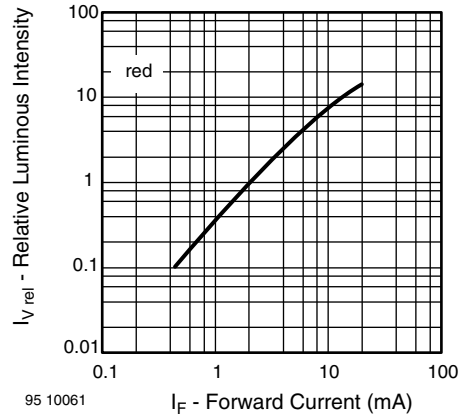


Fig. 6 - Relative Luminous Intensity vs. Forward Current

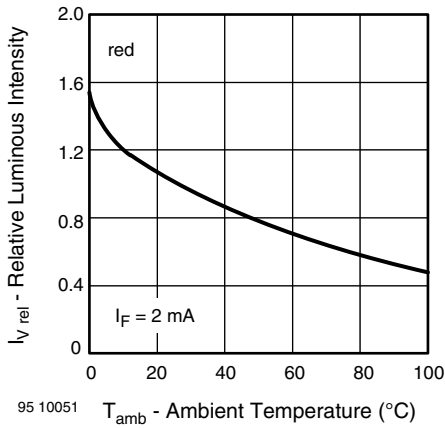


Fig. 4 - Relative Luminous Intensity vs. Ambient Temperature

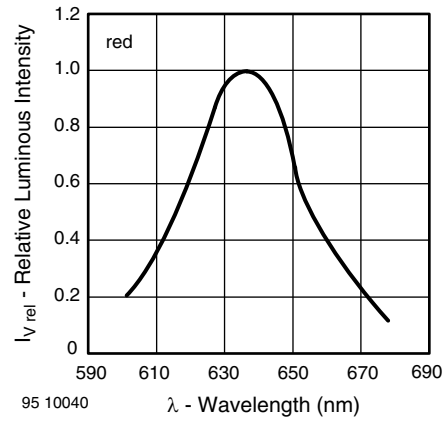


Fig. 7 - Relative Intensity vs. Wavelength

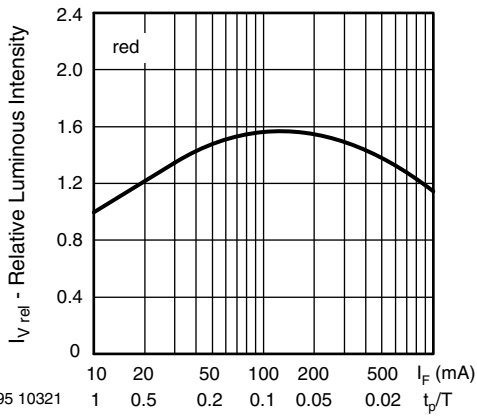
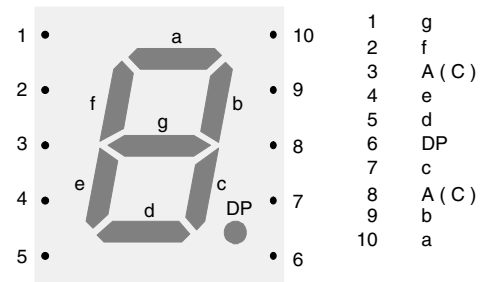


Fig. 5 - Relative Luminous Intensity vs. Forward Current/Duty Cycle

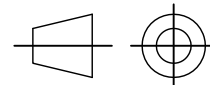
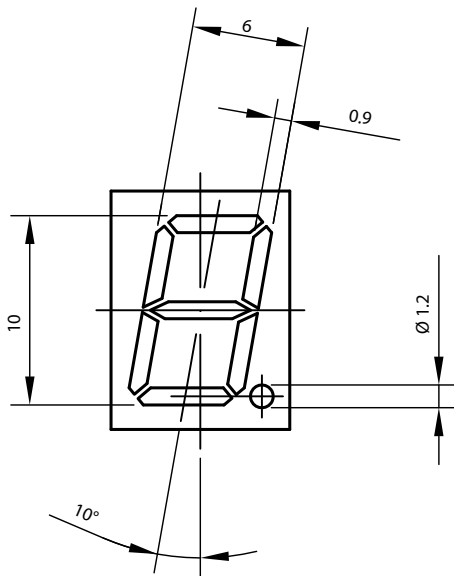
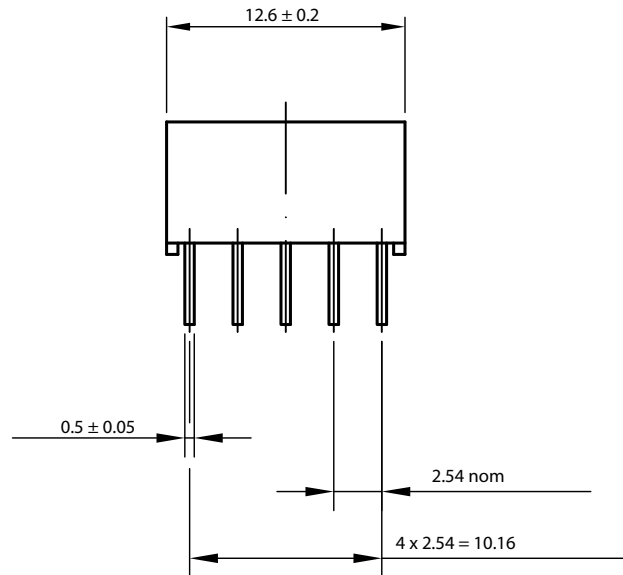
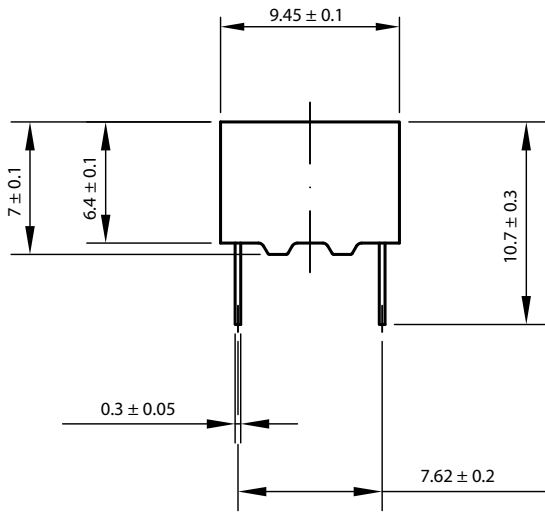


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Fig. 8 - TDSL31..



PACKAGE DIMENSIONS in millimeters

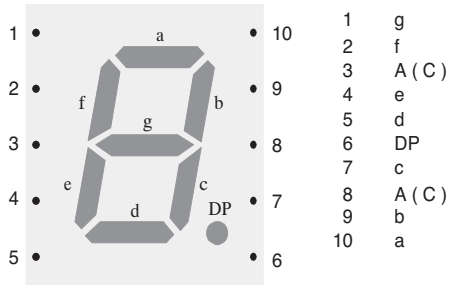


technical drawings
according to DIN
specifications

Drawing-No.: 6.544-5093.01-4
Issue: 2; 23.03.2012



Pin Connections 10 mm



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Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

**We reserve the right to make changes to improve technical design
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